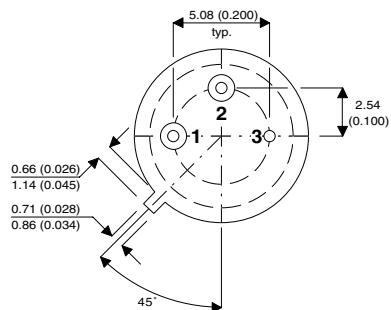
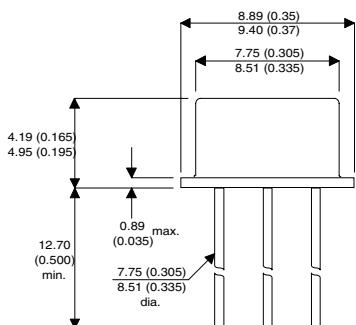


**SEME  
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**2N6660X**

## MECHANICAL DATA

Dimensions in mm (inches)



## TO-39 METAL PACKAGE

### Underside View

PIN 1 – Source  
PIN 2 – Gate

PIN 3 – Drain  
CASE – Drain

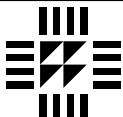
## N-CHANNEL ENHANCEMENT MODE MOS TRANSISTOR

### FEATURES

- Switching Regulators
- Converters
- Motor Drivers

## ABSOLUTE MAXIMUM RATINGS ( $T_{CASE} = 25^\circ\text{C}$ unless otherwise stated)

$V_{DS}$	Drain – Source Voltage	60V
$V_{GS}$	Gate – Source Voltage	$\pm 40\text{V}$
$I_D$	Continuous Drain Current @ $T_{CASE} = 25^\circ\text{C}$	$\pm 1.1\text{A}$
$I_D$	Continuous Drain Current @ $T_{CASE} = 100^\circ\text{C}$	$\pm 0.8\text{A}$
$I_{DM}$	Pulsed Drain Current *	$\pm 3\text{A}$
$P_D$	Power Dissipation @ $T_{CASE} = 25^\circ\text{C}$	6.25W
$P_D$	Power Dissipation @ $T_{CASE} = 100^\circ\text{C}$	2.5W
$T_j$	Operating Junction Temperature Range	-55 to $150^\circ\text{C}$
$T_{stg}$	Storage Temperature Range	-55 to $150^\circ\text{C}$
$T_L$	Lead Temperature (1/16" from case for 10 sec.)	300°C



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## ELECTRICAL CHARACTERISTICS ( $T_{CASE} = 25^\circ\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>STATIC CHARACTERISTICS</b>					
$\text{BV}_{\text{DSS}}$	Drain – Source Breakdown Voltage $V_{GS} = 0\text{V}$ $I_D = 10\mu\text{A}$	60	100		V
$V_{GS(\text{th})}$	Gate Threshold Voltage $V_{DS} = V_{GS}$ $I_D = 1\text{mA}$	0.8	1.5	2.2	
$I_{GSS}$	Gate – Body Leakage Current $V_{GS} = \pm 15\text{V}$		1	$\pm 100$	nA
	$V_{DS} = 0\text{V}$ $T_{CASE} = 125^\circ\text{C}$		5	$\pm 500$	
$I_{DSS}$	Zero Gate Voltage Drain Current $V_{DS} = \text{Max. Ratings}$ $V_{GS} = 0\text{V}$		1	10	$\mu\text{A}$
	$V_{DS} = 0.8\text{V}$ Max. Ratings $V_{GS} = 0\text{V}$ $T_{CASE} = 125^\circ\text{C}$		50	500	
$I_{D(\text{on})^*}$	On-State Drain Current $V_{DS} = \geq 2V_{DS(\text{ON})}$ $V_{GS} = 10\text{V}$	1.5	1.7		A
$R_{DS(\text{on})^*}$	Drain – Source On Resistance $V_{GS} = 5\text{V}$ $I_D = 0.3\text{A}$		4.7	5	$\Omega$
	$V_{GS} = 10\text{V}$		2.7	3	
	$I_D = 1\text{A}$ $T_{CASE} = 125^\circ\text{C}$		3.9	4.2	
$V_{DS(\text{on})^*}$	Drain – Source On Voltage $V_{GS} = 5\text{V}$ $I_D = 0.3\text{A}$		1.4	1.5	V
	$V_{GS} = 10\text{V}$ $I_D = 1\text{A}$		2.7	3	
<b>DYNAMIC CHARACTERISTICS</b>					
$g_{FS}^*$	Forward Transconductance $V_{DS} = 25\text{V}$ $I_D = 0.5\text{A}$	170	195		mS
$C_{iss}$	Input Capacitance		35	50	pF
$C_{oss}$	Output Capacitance		33	40	
$C_{rss}$	Reverse Transfer Capacitance		2	10	
<b>SWITCHING CHARACTERISTICS</b>					
$t_{ON}$	Turn-On Time $V_{DD} = 25\text{V}$ $I_D = 1\text{A}$		8	10	ns
$t_{OFF}$	Turn-Off Time $R_L = 23\Omega$ $R_G = 25\Omega$		8	10	
<b>BODY-DRAIN DIODE RATINGS AND CHARACTERISTICS</b>					
$I_S$	Continuous Source Current (Body Diode)	Modified MOSPOWER Symbol Showing The Integral PN Junction Rectifier			-1.1
$I_{SM}$	Source Current <sup>1</sup> (Body Diode)				-3
$V_{SD}$	Diode Forward Voltage <sup>1</sup>	$I_S = -1.1\text{A}$ $V_{GS} = 0\text{V}$ $T_{CASE} = 125^\circ\text{C}$			-0.9

1 Pulse Test: Pulse width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$

Parameter	Min.	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Free Air Operation)		170	C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		20	C/W